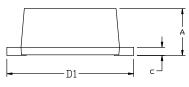
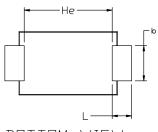


А





FRONT VIEW



BOTTOM VIEW

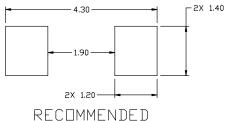
SOD-123FA CASE 425AB ISSUE A

DATE 11 AUG 2022

NDTES

- 1. NO INDUSTRY STANDARD APPLIES TO THIS PACKAGE.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.
- 3. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND THE BAR PROTRUSIONS.

DIM	MILLIMETERS			
	MIN.	NDM.	MAX.	
A	1.23	1.33	1.43	
b	0,80	1.00	1.20	
C	0.16	0.23	0.30	
D	2.70	2,80	2.90	
D1	3.40	3,60	3.80	
E	1.70	1.80	1.90	
He	2.45		2.60	
L	0.35	0.60	0.85	



## MOUNTING FOOTPRINT\*

\* For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

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